

# Introduction to QuickAI™ EOS-S3-AI Hardware Development Platforms (HDKs)

*Board: Merced Rev 1.1*

*Document Rev 1.2 (January 22, 2019)*



# HDK PLATFORMS



MERCED 1.1 HDK

- Merced 1.1 HDK: Industrial Applications
  - Time series data collection & model generation
  - Time series Application development
  - Support Arduino form-factor to take advantage of available modules
  - All S3AI pins are available for expansion

# HDK PLATFORMS

- Chillkat HDK: Consumer Applications
  - Wearable/Mobile Application demo
  - Small Form-Factor (watch like)
  - Limited available IO for feature expansion

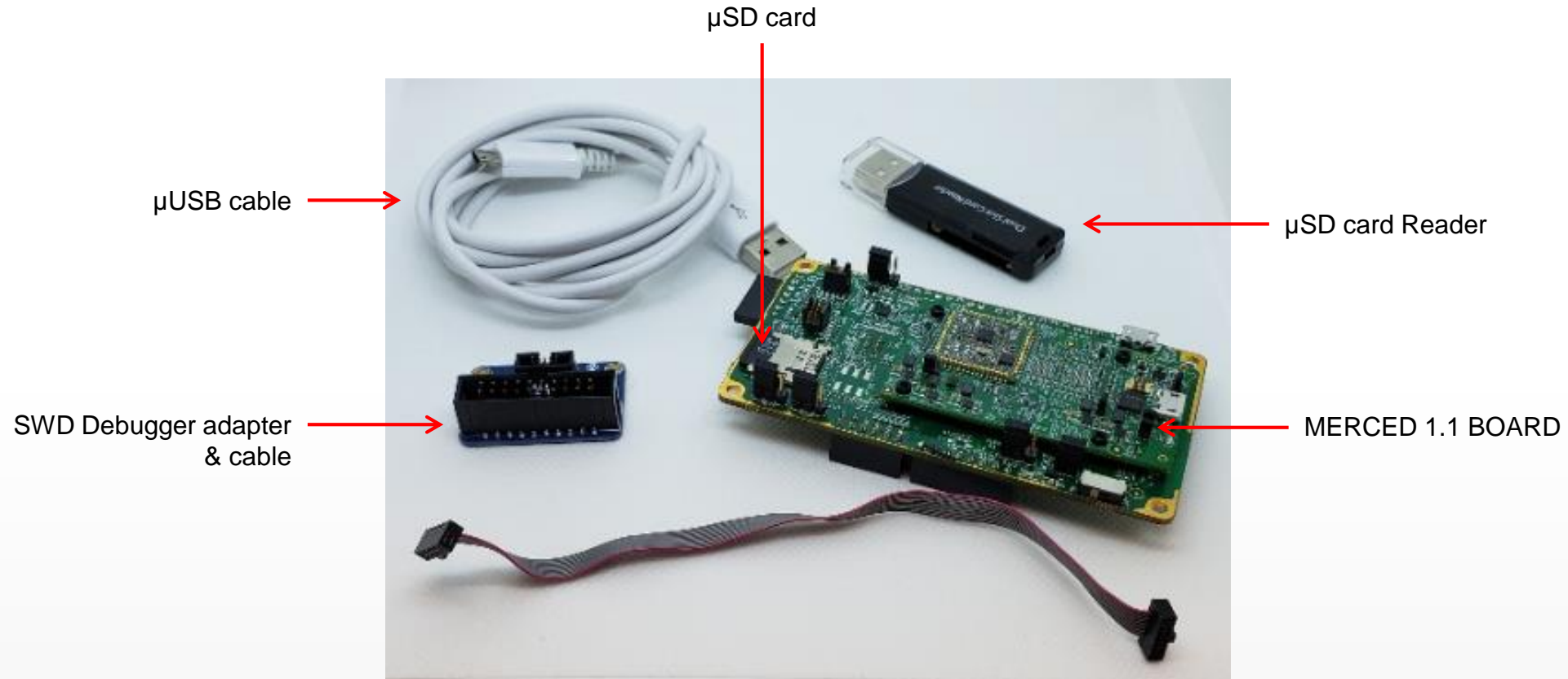


CHILLKAT HDK

# HDK PLATFORMS: COMPARE & CONTRAST

- Merced 1.1 HDK
  - What you received today
  - Includes SD Card Feature for AI data Capture
    - Code supports this, but not demonstrated today.
    - BLE Transfer speed is limit to about 100HZ
    - Can stream much more data directly to SD Card
  - This board is in the top of the Fan Demo
- Chillkat HDK
  - Demo & Shown – not handed out
    - Limited supply – if needed, contact QuickLogic Marketing
  - Fits the Wearables-AI market
  - Can do everything Merced 1.1 can do – except NO SD Card
  - Light Sensor and Vibration Motor

# MERCED 1.1 HDK: CONTENT

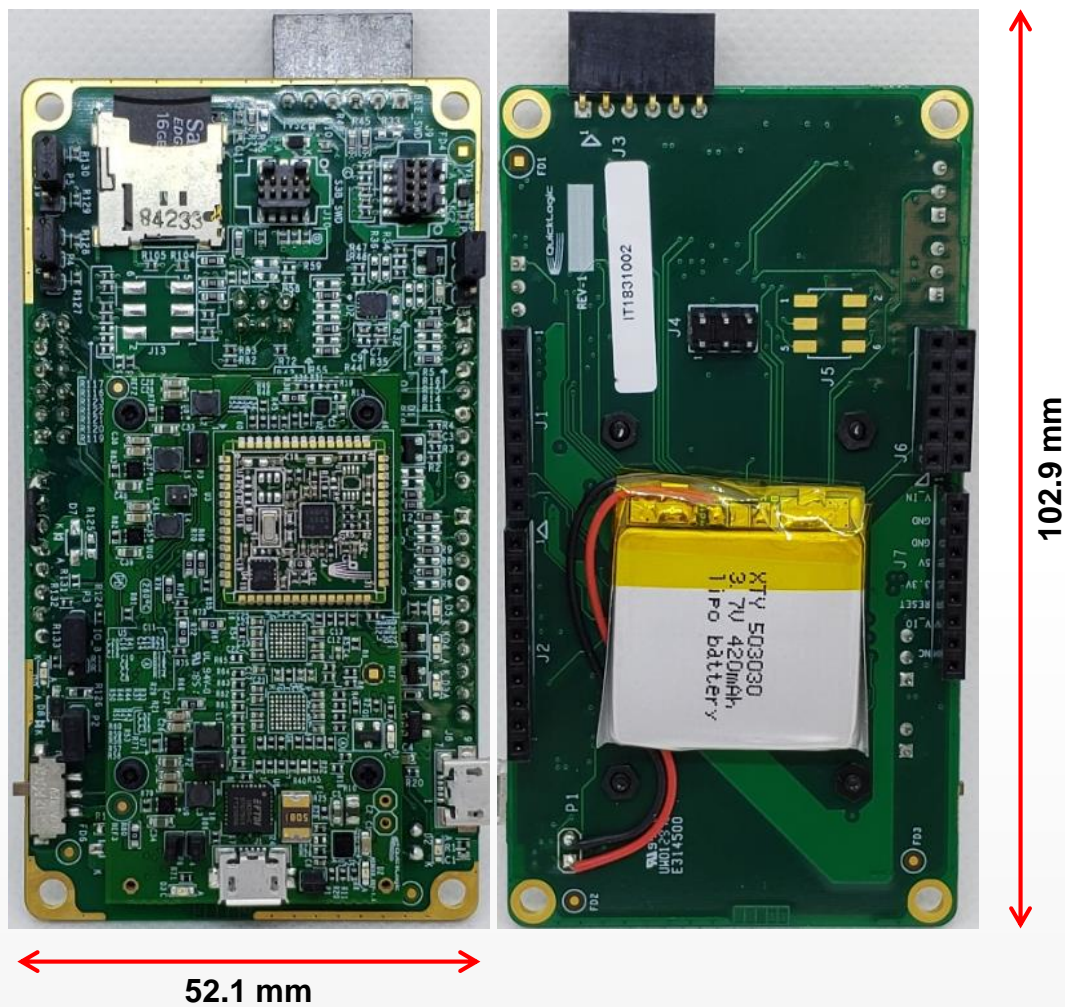


# MERCED 1.1 HDK: FEATURES

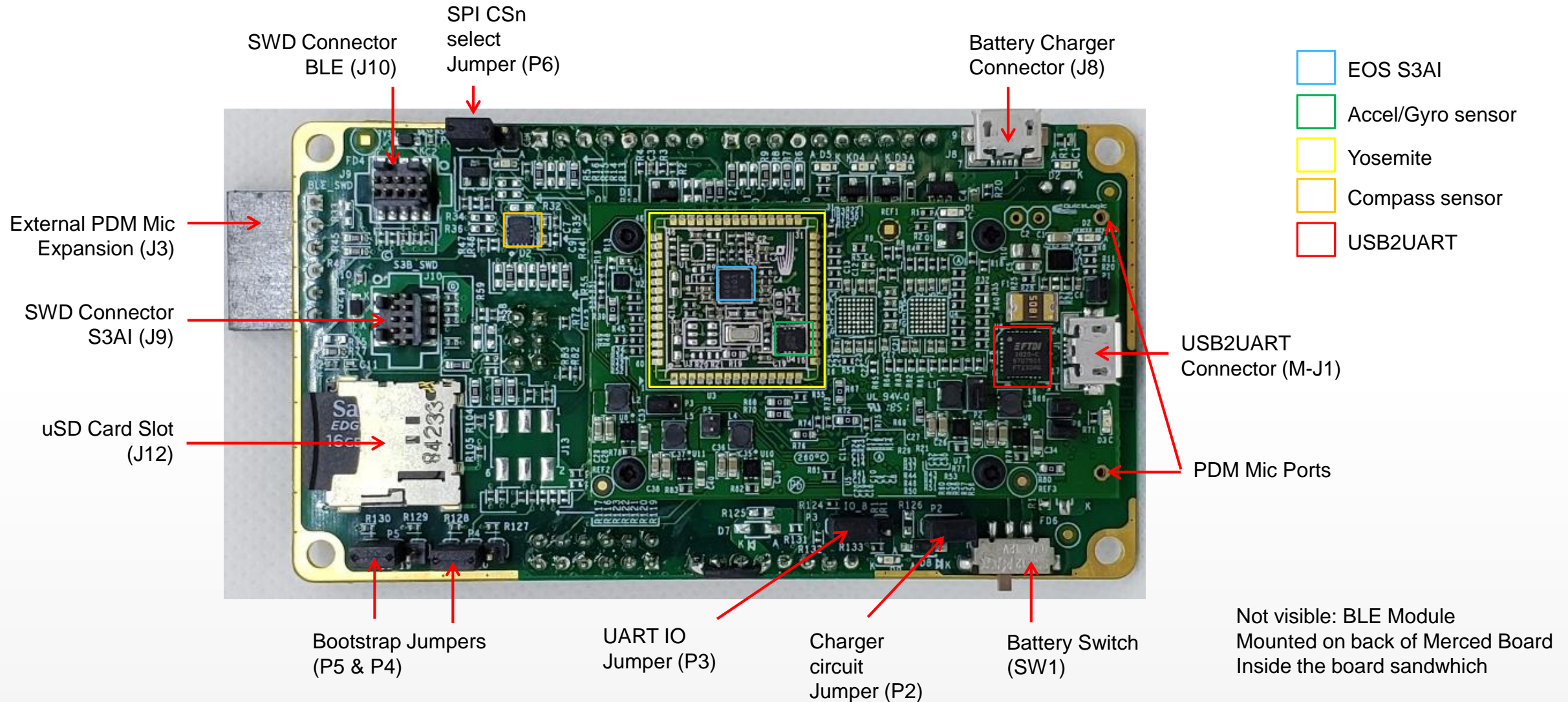
- QuickAI™ S3AI (BGA package)
- Sensors:
  - 6-axis Accel/Gyro sensor (LSM6DSL)
  - 3-axis Compass (AKM9915)
  - Pulse Density Modulation Microphones (Knowles SPH0641LM4H) – 2x
- 4MB SPI Flash for system information
- USB to UART for system control and debug (FTDI-FT232R)
- Onboard BLE module (BMD200 – nRF51822)
- Arduino connectors
- Boot mode jumpers
- IO Voltage selection jumpers (1.8V and 3.3V)
- Standard ARM SWD Debug connectors
- Li-ion battery and battery charging circuit (see next slide)



# MERCED 1.1 HDK: DIMENSION

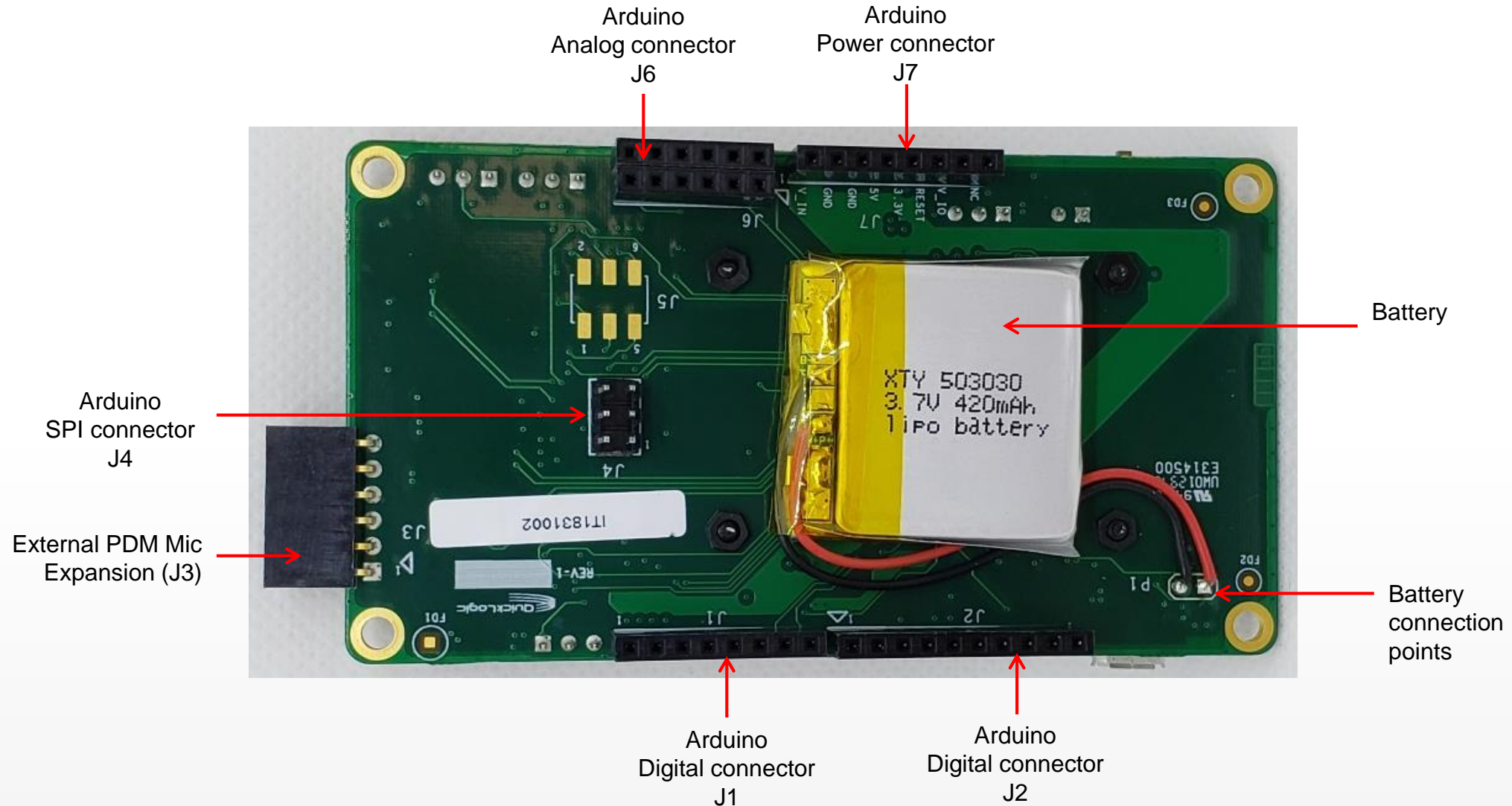


# MERCED 1.1 HDK: CLOSER LOOK (TOP)

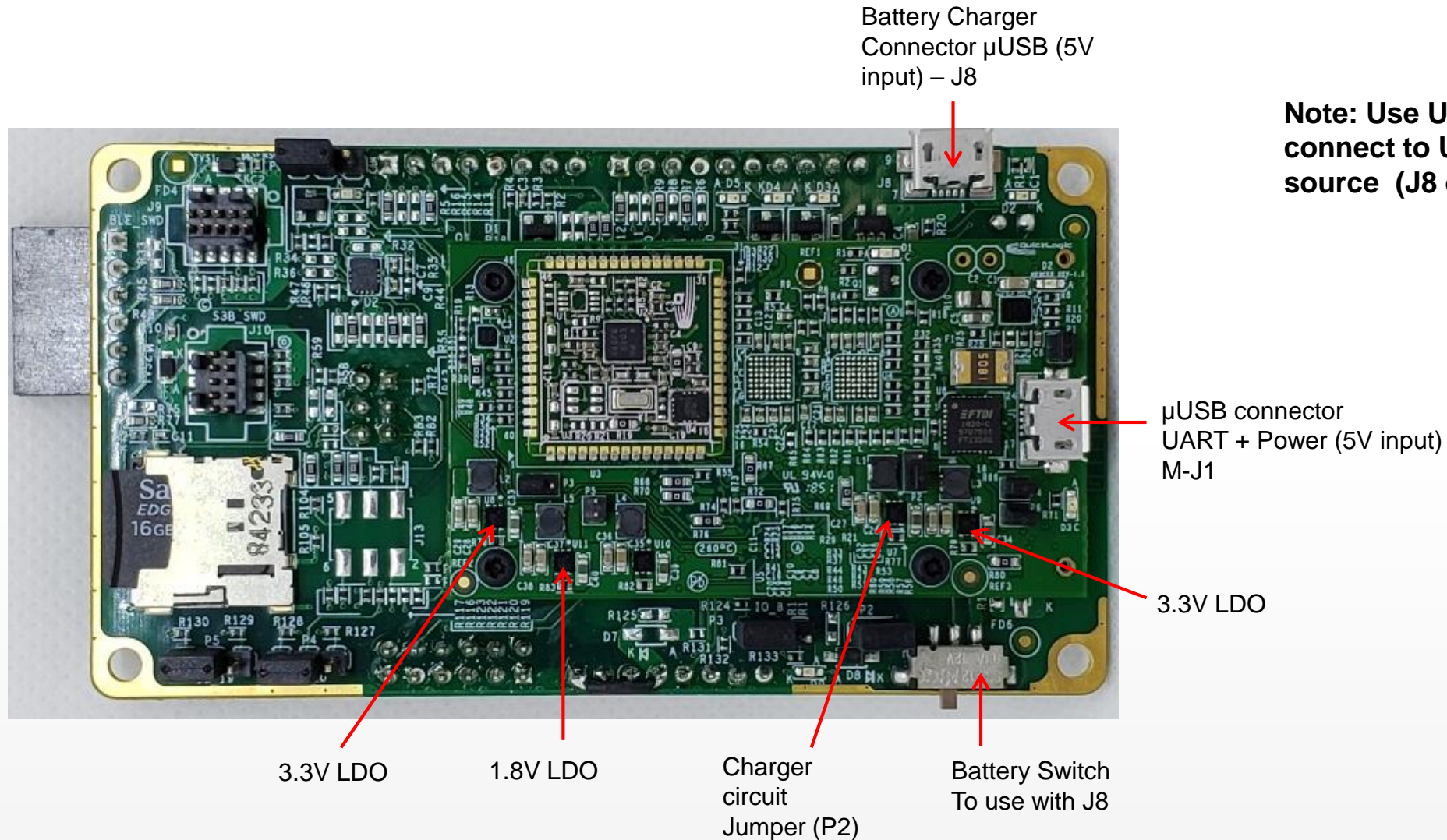




# MERCED 1.1 HDK: CLOSER LOOK (BOTTOM)

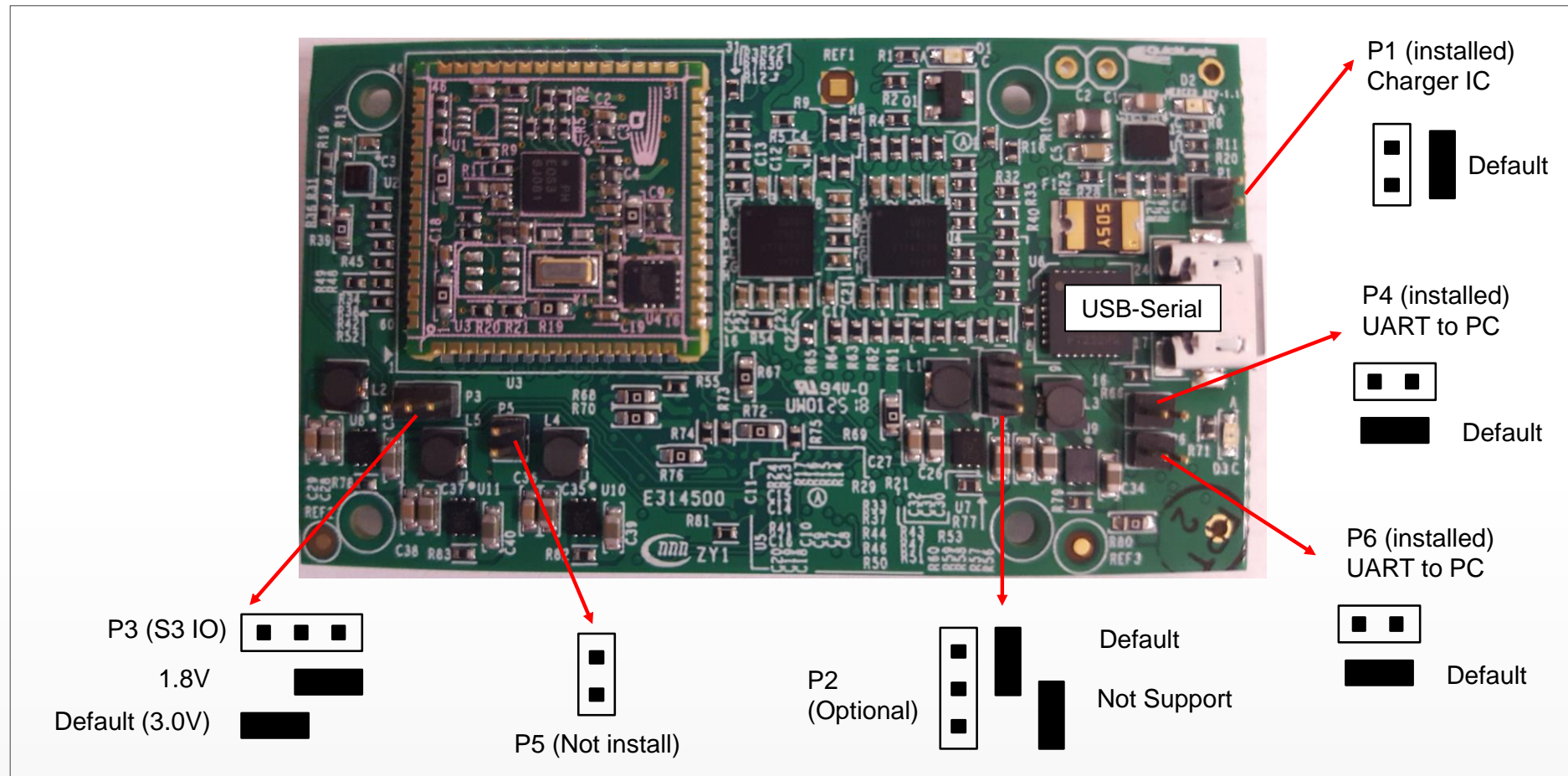


# MERCED 1.1 HDK: OPERATIONS - POWER

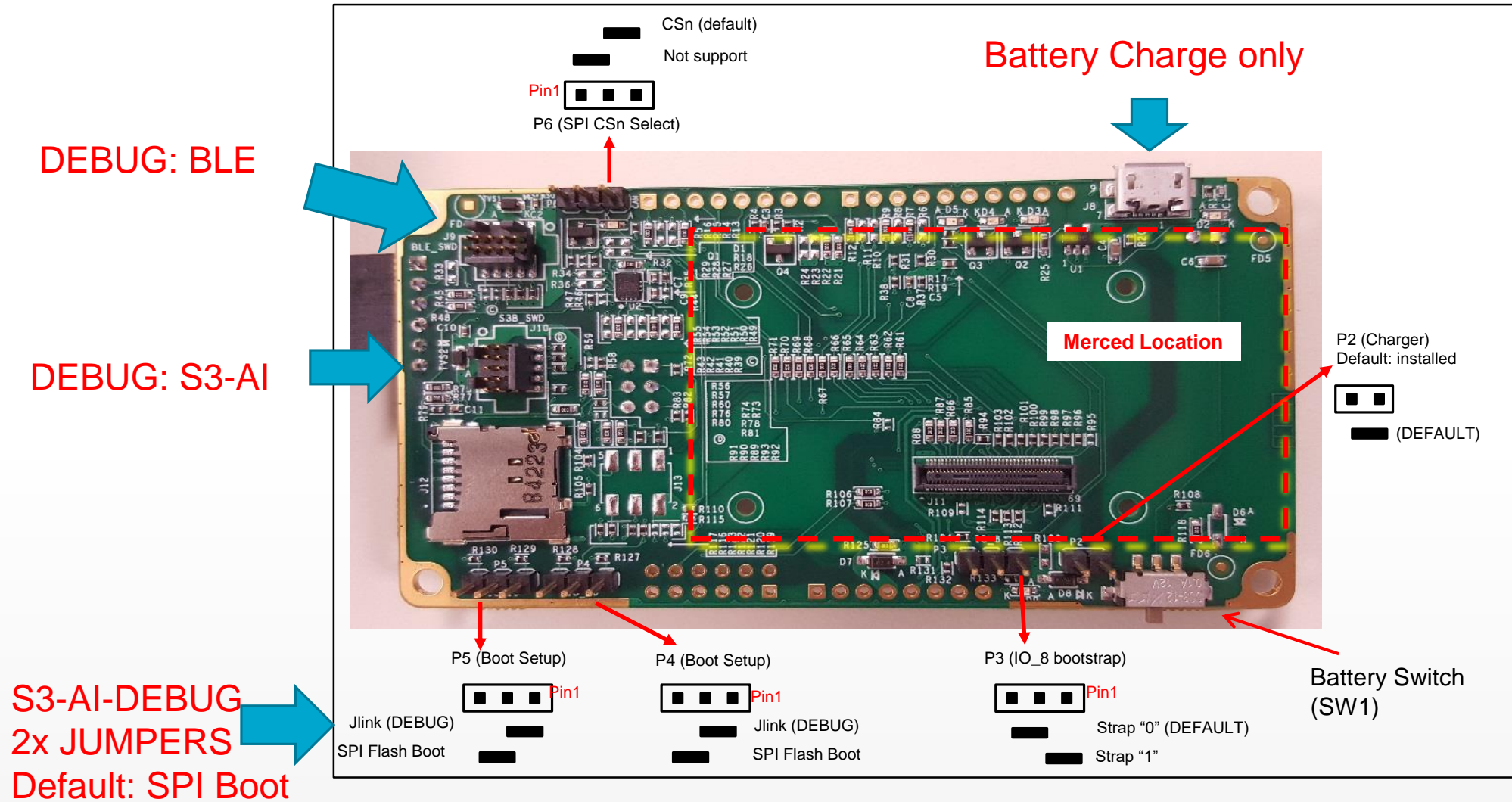




# MERCED 1.1 Jumpers



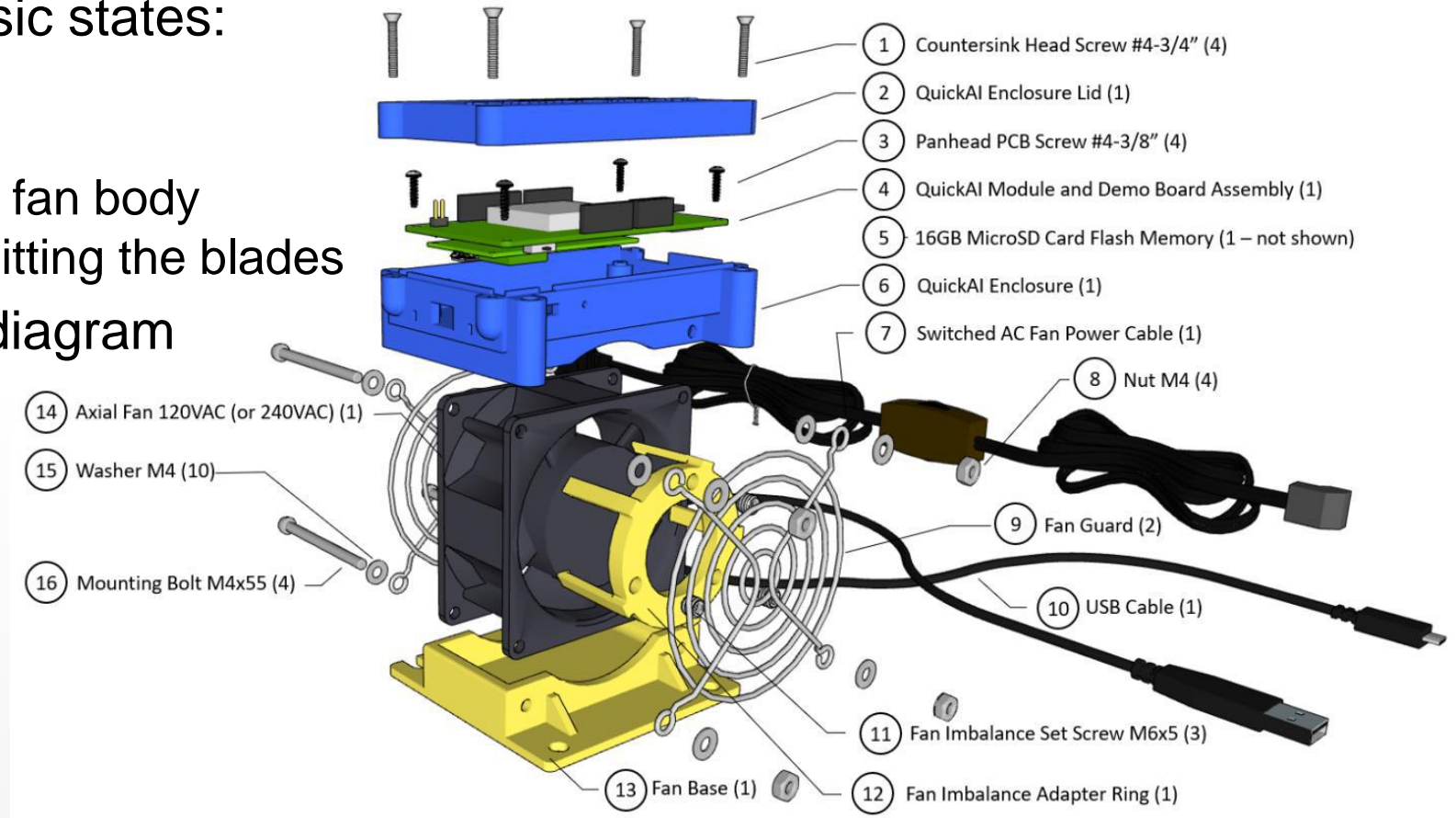
# MERCED 1.1 Debug Board Jumpers





# MERCED 1.1 HDK: PreProgramming

- Pre-Programed Software
  - The Merced Board is programed with a “Fan Demo”
- The AI-model can detect 4 basic states:
  - Off – no vibration
  - On – some vibration
  - Shock – striking or hitting the fan body
  - Imped – On, but something hitting the blades
- See item (4) in the assembly diagram



# MERCED 1.1 HDK: Connecting to external devices/modules

- Direct connection to available Arduino shields; standard Arduino signals (I2C bus, SPI Master, GPIO, ADC) and DC supplies (1.8V and 3.3V) are available via connector J1, J2, J4, J6, J7.
- External PDM Microphone signals are available via connector J3.
- Blue-wiring is possible for external sensors that support either I2C or SPI bus protocol

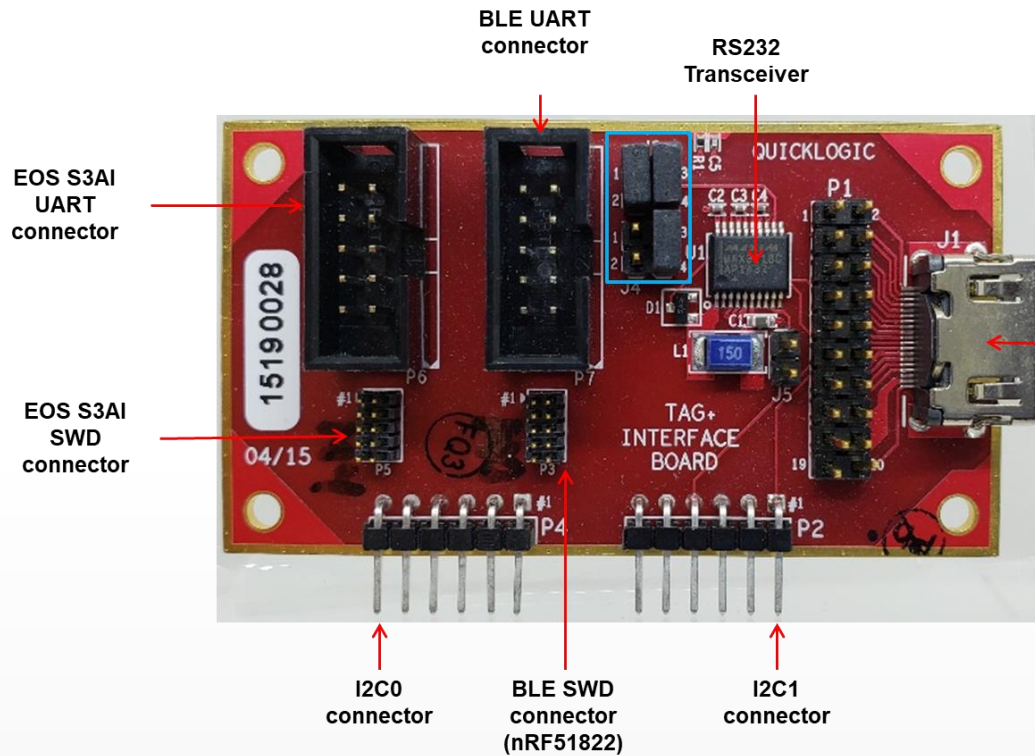


# CHILLKAT HDK: CONTENT

Chillkat in Watch Band



# Chillkat Break Out Board – Via HDMI Cable



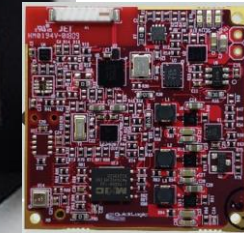
UART connection configuration: Null Modem / Normal

HDMI connector J1

HDMI Breakout Cable



TOP VIEW



BOTTOM VIEW



Micro HDMI Connector

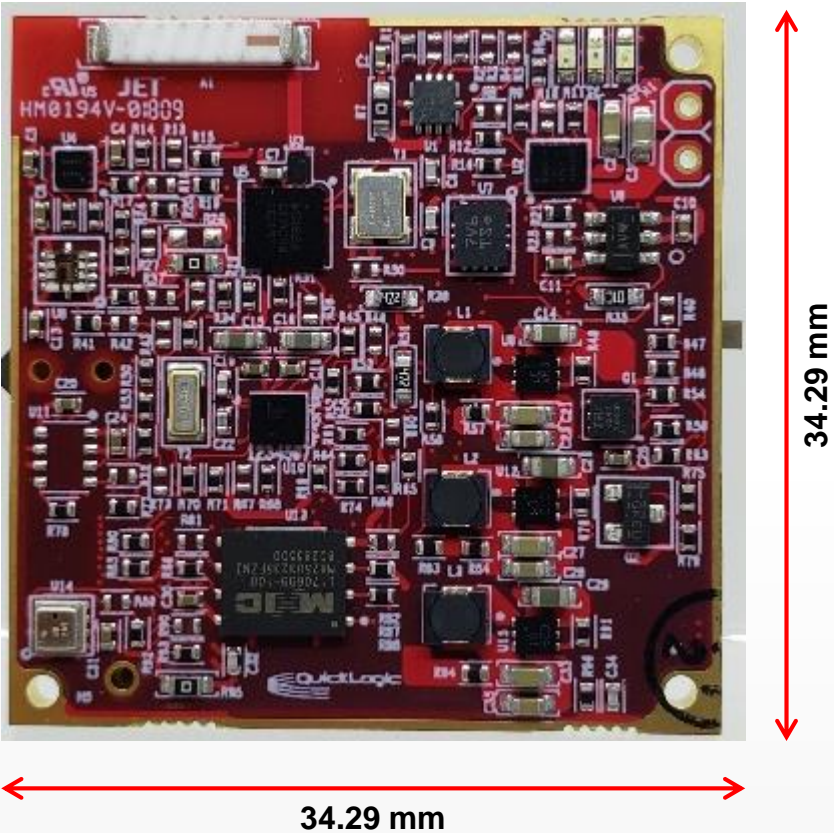


# CHILLKAT HDK: FEATURES

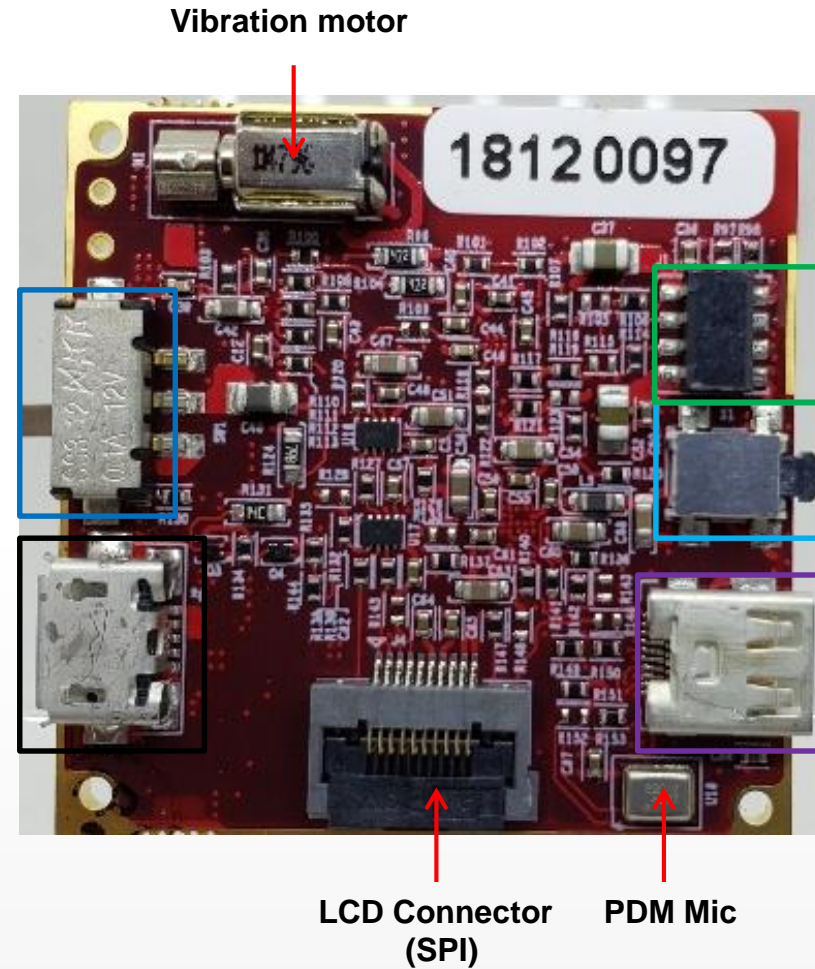
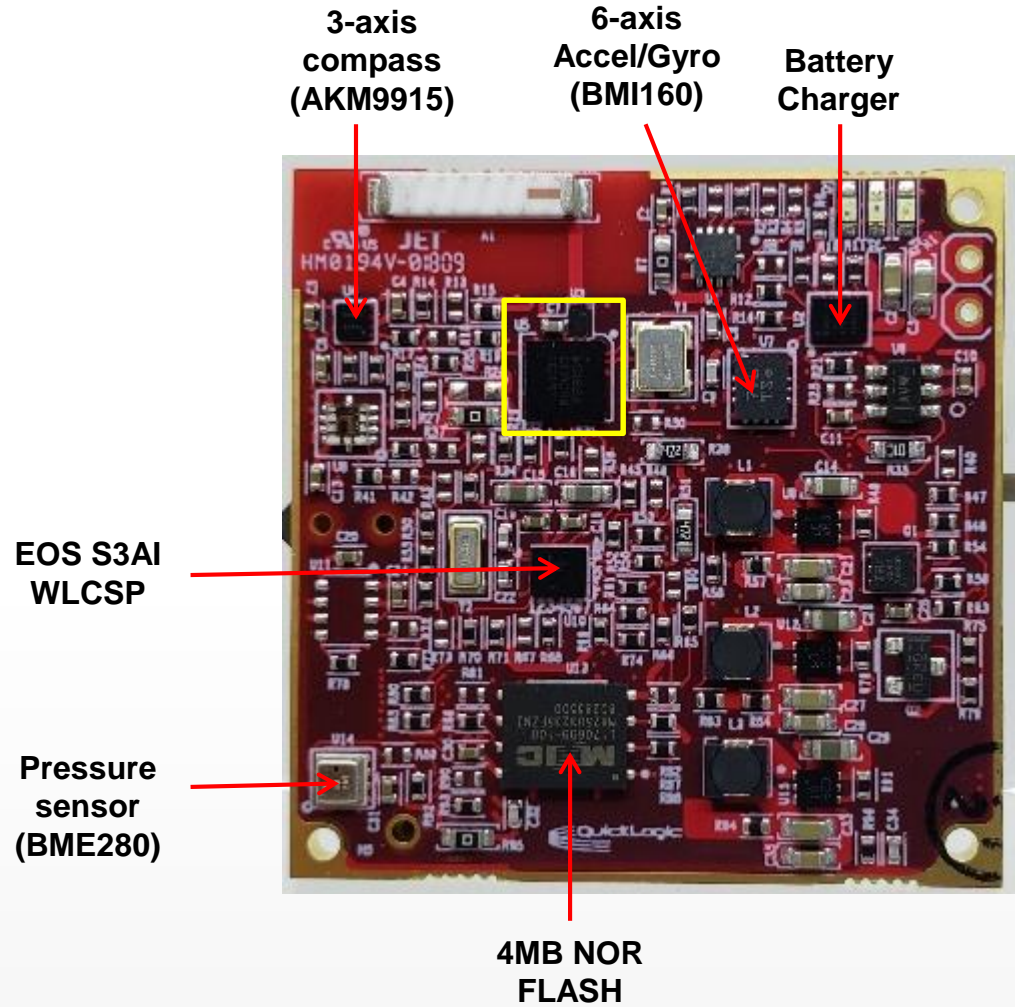
- QuickAI™ S3AI WLCSP (Wafer Level Chip Scale Package)
- Sensors:
  - 6-axis Accel/Gyro sensor (Bosch BMI160)
  - 3-axis Compass (AKM9915)
  - UV+Ambient Light sensor (Si1132) – not on Merced HDK
  - Pulse Density Modulation Microphones (Knowles SPH0641LM4H)
- 4MB Serial NOR Flash for system information
- Onboard BLE device (nRF51822)
- µHDMI connector + cable for expansion features
- Standard ARM SWD Debug connectors via Debug Board
- Li-ion battery and battery charging circuit
- Onboard vibrator motor – not on Merced HDK
- Watch band housing to emphasize freedom of movement (Sam?)

# CHILLKAT HDK: CHILLKAT BOARD DIMENSION

Thickness: 4 mm



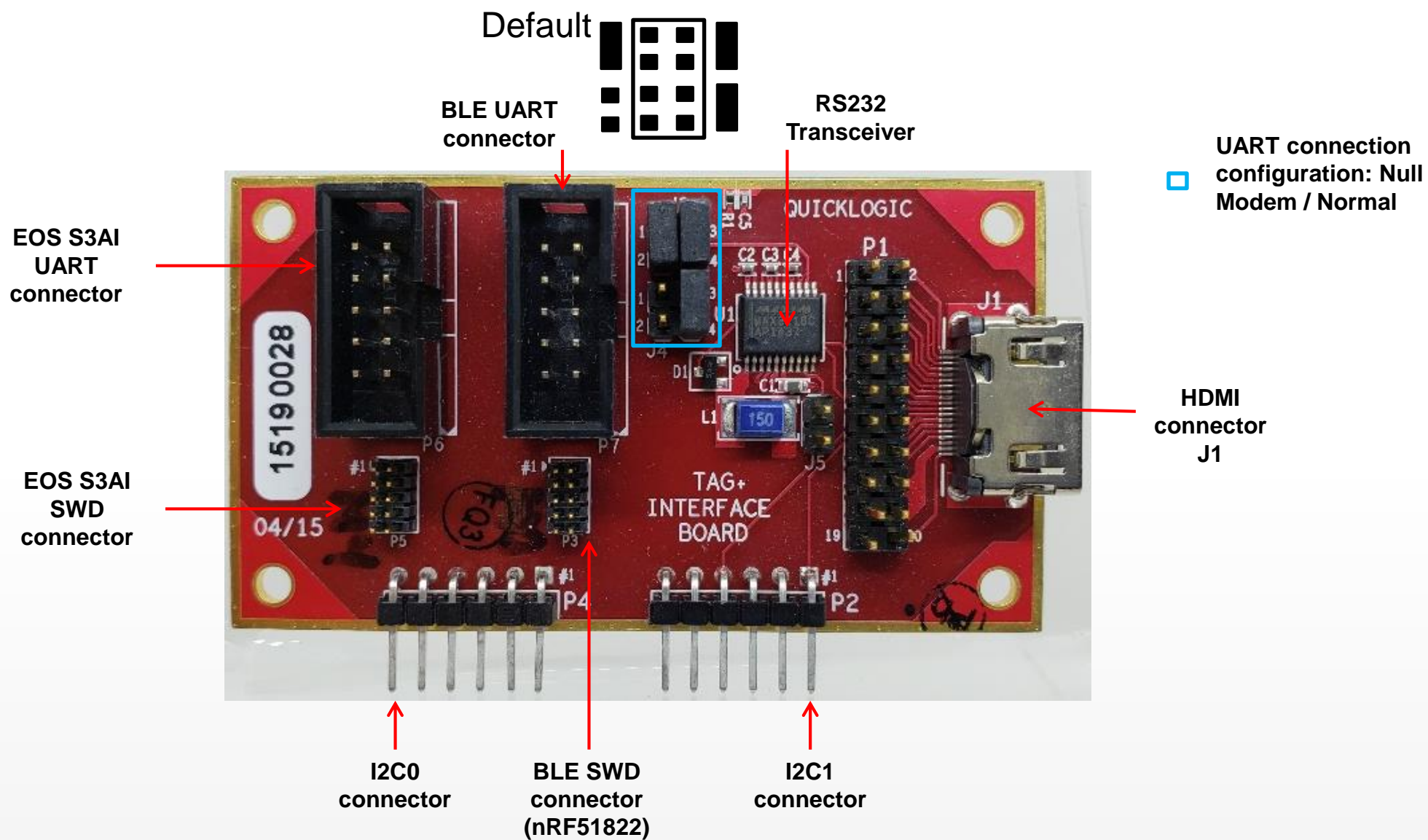
# CHILLKAT HDK: CHILLKAT BOARD CLOSE LOOK



- ☐ USB Power
- ☐ Power Switch
- ☐ BLE (nRF51822)
- ☐ Expansion connector
- ☐ Reset button
- ☐ I2C with Power expansion port



# CHILLKAT HDK: DESPLAINES BOARD CLOSE LOOK





# GOOD TO KNOW

- BGA/ WLCSP package available now, QFN available 2019Q2
- SW SDK available now – Supports Eclipse/GCC and IAR
  - On your thumb drive
- S3AI core current measurement via jumper shunt
  - See HDK docs for details
- Merced 1.1 – you have this
  - If Chilkat needed please contact Quicklogic for availability
- Out of box demo:
  - Android App: SensiML – Data Collection Lab (DCL)
  - Android App: SensiML – Test App
  - Merced v1.1 come pre-programed with “SensiML Gesture Demo”